## Comlinear ${ }^{\odot}$ CLC2000, CLC4000 High Output Current Dual and Quad Amplifiers

## FEATURES

- $9.4 \mathrm{~V}_{\mathrm{pp}}$ output drive into $\mathrm{R}_{\mathrm{L}}=25 \Omega$
- Using both amplifiers, 18.8 Vpp differential output drive into $R_{L}=25 \Omega$
- $\pm 200 \mathrm{~mA} @ \mathrm{~V}_{0}=9.4 \mathrm{~V}$ pp
- 0.009\%/0.06 ${ }^{\circ}$ differential gain/
phase error
- $250 \mathrm{MHz}-3 \mathrm{~dB}$ bandwidth at $\mathrm{G}=2$
- $510 \mathrm{MHz}-3 \mathrm{~dB}$ bandwidth at $\mathrm{G}=1$
- 210V/us slew rate
- $4.5 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$ input voltage noise
- $2.7 \mathrm{pA} / \sqrt{ } \mathrm{Hz}$ input current noise
- 7mA supply current
- Fully specified at 5V and 12 V supplies


## APPLICATIONS

- ADSL PCI modem cards
- ADSL external modems
- Cable drivers
- Video line driver
- Twisted pair driver/receiver
- Power line communications


## General Description

The Comlinear CLC2000 and CLC4000 are dual and quad voltage feedback amplifiers that offer $\pm 200 \mathrm{~mA}$ of output current at $9.4 \mathrm{~V}_{\mathrm{pp}}$. The CLC2000 and CLC4000 are capable of driving signals to within 1 V of the power rails. When connected as a differential line driver, the amplifier drives signals up to 18.8 Vpp into a $25 \Omega$ load, which supports the peak upstream power levels for upstream full-rate ADSL CPE applications.

The Comlinear CLC2000 and CLC4000 can operate from single or dual supplies from 5 V to 12 V . It consumes only 7 mA of supply current per channel. The combination of wide bandwidth, low noise, low distortion, and high output current capability makes the CLC2000 and CLC4000 ideally suited for Customer Premise ADSL or video line driving applications.

Typical Application - ADSL Application


Ordering Information

| Part Number | Package | Pb-Free | Operating Temperature Range | Packaging Method |
| :--- | :--- | :--- | :--- | :--- |
| CLC2000ISO8X | SOIC-8 | Yes | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Reel |
| CLC2000ISO8 | SOIC-8 | Yes | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Rail |
| CLC4000ISO14X | SOIC-14 | Yes | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Reel |
| CLC4000ISO14 | SOIC-14 | Yes | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Rail |

Moisture sensitivity level for all parts is MSL-1.


## CLC2000 Pin Configuration



## CLC2000 Pin Assignments

| Pin No. | Pin Name | Description |
| :---: | :---: | :--- |
| 1 | OUT1 | Output, channel 1 |
| 2 | -IN1 | Negative input, channel 1 |
| 3 | + IN1 | Positive input, channel 1 |
| 4 | $-V_{S}$ | Negative supply |
| 5 | + IN2 | Positive input, channel 2 |
| 6 | - IN2 | Negative input, channel 2 |
| 7 | OUT2 | Output, channel 2 |
| 8 | $+V_{S}$ | Positive supply |

CLC4000 Pin Assignments

| Pin No. | Pin Name | Description |
| :---: | :---: | :--- |
| 1 | OUT1 | Output, channel 1 |
| 2 | -IN1 | Negative input, channel 1 |
| 3 | + IN1 | Positive input, channel 1 |
| 4 | + VS | Positive supply |
| 5 | + IN2 | Positive input, channel 2 |
| 6 | -IN2 | Negative input, channel 2 |
| 7 | OUT2 | Output, channel 2 |
| 8 | OUT3 | Output, channel 3 |
| 9 | -IN3 | Negative input, channel 3 |
| 10 | + IN3 | Positive input, channel 3 |
| 11 | -VS | Negative supply |
| 12 | + IN4 | Positive input, channel 4 |
| 13 | -IN4 | Negative input, channel 4 |
| 14 | OUT4 | Output, channel 4 |



## Absolute Maximum Ratings

The safety of the device is not guaranteed when it is operated above the "Absolute Maximum Ratings". The device should not be operated at these "absolute" limits. Adhere to the "Recommended Operating Conditions" for proper device function. The information contained in the Electrical Characteristics tables and Typical Performance plots reflect the operating conditions noted on the tables and plots.

| Parameter | Min | Max | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | 0 | $\pm 7$ or 14 | V |
| Input Voltage Range | $-\mathrm{V}_{\mathrm{S}}-0.5 \mathrm{~V}$ | $+\mathrm{V}_{\mathrm{S}}+0.5 \mathrm{~V}$ | V |

Reliability Information

| Parameter | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Junction Temperature |  |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | -65 |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10s) |  |  | 260 | ${ }^{\circ} \mathrm{C}$ |
| Package Thermal Resistance |  | 100 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 8-Lead SOIC |  | 88 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14-Lead SOIC |  |  |  |  |

Notes:
Package thermal resistance $\left(\theta_{\mathrm{JA}}\right)$, JDEC standard, multi-layer test boards, still air.
ESD Protection

| Product |  |
| :--- | :---: |
| Human Body Model (HBM) | 2.5 kV |
| Charged Device Model (CDM) | 2 kV |

## Recommended Operating Conditions

| Parameter | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Operating Temperature Range | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| Supply Voltage Range | $\pm 2.5$ |  | $\pm 6.5$ | V |

## Electrical Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=\mathrm{R}_{\mathrm{g}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Response |  |  |  |  |  |  |
| UGBW | -3dB Bandwidth | $\mathrm{G}=+1, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\text {pp, }}, \mathrm{R}_{\mathrm{f}}=0$ |  | 422 |  | MHz |
| $\mathrm{BW}_{\text {SS }}$ | -3dB Bandwidth | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\mathrm{pp}}$ |  | 236 |  | MHz |
| $\mathrm{BW}_{\mathrm{LS}}$ | Large Signal Bandwidth | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=2 \mathrm{~V}_{\mathrm{pp}}$ |  | 68 |  | MHz |
| $\mathrm{BW}_{0.1 \mathrm{~dB}}$ | 0.1dB Gain Flatness | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\mathrm{pp}}$ |  | 77 |  | MHz |
| Time Domain Response |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{R},} \mathrm{t}_{\mathrm{F}}$ | Rise and Fall Time | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}$ step; ( $10 \%$ to $90 \%$ ) |  | 3.7 |  | ns |
| $\mathrm{t}_{5}$ | Settling Time to 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ step |  | 20 |  | ns |
| OS | Overshoot | $\mathrm{V}_{\text {OUT }}=0.2 \mathrm{~V}$ step |  | 6 |  | \% |
| SR | Slew Rate | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ step |  | 200 |  | V/us |
| Distortion/Noise Response |  |  |  |  |  |  |
| HD2 | 2nd Harmonic Distortion | $2 \mathrm{~V}_{\text {pp }}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -83 |  | dBc |
|  |  | $2 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -85 |  | dBc |
| HD3 | 3rd Harmonic Distortion | $2 \mathrm{~V}_{\text {pp }}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -86 |  | dBc |
|  |  | $2 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -82 |  | dBc |
| $\mathrm{D}_{\mathrm{G}}$ | Differential Gain | NTSC (3.58MHz), DC-coupled, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.01 |  | \% |
| $\mathrm{D}_{\mathrm{p}}$ | Differential Phase | NTSC (3.58MHz), DC-coupled, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.05 |  | - |
| $\mathrm{e}_{\mathrm{n}}$ | Input Voltage Noise | $>1 \mathrm{MHz}$ |  | 4.2 |  | $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |
| $i_{n}$ | Input Current Noise | $>1 \mathrm{MHz}$ |  | 2.7 |  | $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |
| $\mathrm{X}_{\text {TALK }}$ | Crosstalk | Channel-to-channel 5MHz |  | -63 |  | dB |
| DC Performance |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IO}}$ | Input Offset Voltage |  |  | 0.3 |  | mV |
| $\mathrm{dV}_{\text {IO }}$ | Average Drift |  |  | 0.383 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{IO}}$ | Input Offset Current |  |  | 0.2 |  | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{b}}$ | Input Bias Current |  |  | 10 |  | $\mu \mathrm{A}$ |
| $\mathrm{dI}_{\text {bni }}$ | Average Drift |  |  | 2.5 |  | $n A /{ }^{\circ} \mathrm{C}$ |
| PSRR | Power Supply Rejection Ratio | DC |  | 81 |  | dB |
| $\mathrm{A}_{\mathrm{OL}}$ | Open-Loop Gain | $\mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | 76 |  | dB |
| $\mathrm{I}_{\mathrm{S}}$ | Supply Current | per channel |  | 6.75 |  | mA |
| Input Characteristics |  |  |  |  |  |  |
| $\mathrm{R}_{\mathrm{IN}}$ | Input Resistance | Non-inverting |  | 2.5 |  | M $\Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 1 |  | pF |
| CMIR | Common Mode Input Range |  |  | $\begin{gathered} 0.4 \text { to } \\ 4.6 \end{gathered}$ |  | V |
| CMRR | Common Mode Rejection Ratio | DC |  | 80 |  | dB |
| Output Characteristics |  |  |  |  |  |  |
| $\mathrm{R}_{0}$ | Output Resistance | Closed Loop, DC |  | 0.01 |  | $\Omega$ |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | $\begin{gathered} 0.95 \text { to } \\ 4.05 \\ \hline \end{gathered}$ |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ |  | $\begin{aligned} & 0.75 \text { to } \\ & 4.25 \end{aligned}$ |  | V |
| $\mathrm{I}_{\text {SC }}$ | Short-Circuit Output Current | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{S}} / 2$ |  | 1000 |  | mA |

## Electrical Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=\mathrm{R}_{\mathrm{g}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Response |  |  |  |  |  |  |
| UGBW | -3dB Bandwidth | $\mathrm{G}=+1, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\text {pp, }}, \mathrm{R}_{\mathrm{f}}=0$ |  | 510 |  | MHz |
| $\mathrm{BW}_{\text {SS }}$ | -3dB Bandwidth | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\mathrm{pp}}$ |  | 250 |  | MHz |
| $\mathrm{BW}_{\text {LS }}$ | Large Signal Bandwidth | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=4 \mathrm{~V}_{\text {pp }}$ |  | 35 |  | MHz |
| $B W_{0.1 d B}$ | 0.1dB Gain Flatness | $\mathrm{G}=+2, \mathrm{~V}_{\text {OUT }}=0.2 \mathrm{~V}_{\mathrm{pp}}$ |  | 32 |  | MHz |
| Time Domain Response |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{R},} \mathrm{t}_{\mathrm{F}}$ | Rise and Fall Time | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ step; ( $10 \%$ to $90 \%$ ) |  | 13.3 |  | ns |
| $\mathrm{t}_{\mathrm{s}}$ | Settling Time to 0.1\% | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}$ step |  | 20 |  | ns |
| OS | Overshoot | $\mathrm{V}_{\text {OUT }}=0.2 \mathrm{~V}$ step |  | 2 |  | \% |
| SR | Slew Rate | $\mathrm{V}_{\text {OUT }}=4 \mathrm{~V}$ step |  | 210 |  | $\mathrm{V} / \mathrm{\mu s}$ |
| Distortion/Noise Response |  |  |  |  |  |  |
| HD2 | 2nd Harmonic Distortion | $2 \mathrm{~V}_{\text {pp }}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -84 |  | dBc |
|  |  | $2 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -86 |  | dBc |
|  |  | $8.4 \mathrm{~V}_{\mathrm{pp}}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -63 |  | dBc |
|  |  | $8.4 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -82 |  | dBc |
| HD3 | 3rd Harmonic Distortion | $2 \mathrm{~V}_{\text {pp }}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -88 |  | dBc |
|  |  | $2 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -80 |  | dBc |
|  |  | $8.4 \mathrm{~V}_{\text {pp }}, 100 \mathrm{KHz}, \mathrm{R}_{\mathrm{L}}=25 \Omega$ |  | -63 |  | dBc |
|  |  | $8.4 \mathrm{~V}_{\mathrm{pp}}, 1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | -83 |  | dBc |
| $\mathrm{D}_{\mathrm{G}}$ | Differential Gain | NTSC (3.58MHz), DC-coupled, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.009 |  | \% |
| $\mathrm{D}_{\mathrm{P}}$ | Differential Phase | NTSC (3.58MHz), DC-coupled, $\mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.06 |  | ${ }^{\circ}$ |
| $\mathrm{e}_{\mathrm{n}}$ | Input Voltage Noise | $>1 \mathrm{MHz}$ |  | 4.5 |  | $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |
| $\mathrm{i}_{\mathrm{n}}$ | Input Current Noise | $>1 \mathrm{MHz}$ |  | 2.7 |  | $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |
| $\mathrm{X}_{\text {TALK }}$ | Crosstalk | Channel-to-channel 5MHz |  | -62 |  | dB |
| DC Performance |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IO }}$ | Input Offset Voltage ${ }^{(1)}$ |  | -6 | 0.3 | 6 | mV |
| $\mathrm{dV}_{\text {IO }}$ | Average Drift |  |  | 0.383 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{IO}}$ | Input Offset Current ${ }^{(1)}$ |  | -2 | 0.2 | 2 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{b}}$ | Input Bias Current ${ }^{(1)}$ |  |  | 10 | 20 | $\mu \mathrm{A}$ |
| $\mathrm{dI}_{\text {bni }}$ | Average Drift |  |  | 2.5 |  | $n A /{ }^{\circ} \mathrm{C}$ |
| PSRR | Power Supply Rejection Ratio(1) | DC | 73 | 81 |  | dB |
| $\mathrm{A}_{\text {OL }}$ | Open-Loop Gain | $\mathrm{R}_{\mathrm{L}}=25$ |  | 76 |  | dB |
| $\mathrm{I}_{\mathrm{S}}$ | Supply Current ${ }^{(1)}$ | per channel |  | 7 | 12 | mA |
| Input Characteristics |  |  |  |  |  |  |
| $\mathrm{R}_{\text {IN }}$ | Input Resistance | Non-inverting |  | 2.5 |  | M $\Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 1 |  | pF |
| CMIR | Common Mode Input Range |  |  | $\begin{gathered} 0.6 \text { to } \\ 11.4 \end{gathered}$ |  | V |
| CMRR | Common Mode Rejection Ratio ${ }^{(1)}$ | DC | 70 | 79 |  | dB |
| Output Characteristics |  |  |  |  |  |  |
| $\mathrm{R}_{0}$ | Output Resistance | Closed Loop, DC |  | 0.01 |  | $\Omega$ |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=25 \Omega^{(1)}$ | 1.5 | $\begin{gathered} \hline 1.2 \text { to } \\ 10.8 \\ \hline \end{gathered}$ | 10.5 | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ |  | $\begin{gathered} 0.8 \text { to } \\ 11.2 \\ \hline \end{gathered}$ |  | V |
| $\mathrm{I}_{\text {SC }}$ | Short-Circuit Output Current | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{S}} / 2$ |  | 1000 |  | mA |

## Notes:

1. $100 \%$ tested at $25^{\circ} \mathrm{C}$

## Typical Performance Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

Non-Inverting Frequency Response


Inverting Frequency Response


Frequency Response vs. $\mathrm{R}_{\mathrm{L}}$


Non-Inverting Frequency Response ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )


Inverting Frequency Response ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )


Frequency vs. $R_{L}\left(V_{S}=5 V\right)$


## Typical Performance Characteristics - Continued

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

Frequency vs. $C_{L}$


Recommended Rs. vs. $\mathrm{C}_{\mathrm{L}}$


Frequency Response vs. Vout


Frequency vs. $C_{L}\left(V_{S}=5 \mathrm{~V}\right)$


Recommended $\mathrm{R}_{\mathrm{S}}$ vs. $\mathrm{C}_{\mathrm{L}}\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


Frequency Response vs. $\mathrm{V}_{\text {OUT }}\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


## Typical Performance Characteristics - Continued

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

Frequency Response vs. Temperature

-3dB Bandwidth vs. Output Voltage


Open Loop Transimpendance Gain/Phase vs. Frequency


Frequency vs. Temperature ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )

-3 dB Bandwidth vs. Output Voltage $\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


Input Voltage Noise


## Typical Performance Characteristics - Continued

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

2nd Harmonic Distortion vs. $\mathrm{R}_{\mathrm{L}}$


2nd Harmonic Distortion vs. V OUT


Differential Gain \& Phase AC Coupled


3rd Harmonic Distortion vs. $R_{L}$


3rd Harmonic Distortion vs. VOUT


Differential Gain \& Phase DC Coupled


## Typical Performance Characteristics - Continued

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

2nd Harmonic Distortion vs. $R_{L}\left(V_{S}=5 \mathrm{~V}\right)$


2nd Harmonic Distortion vs. $\mathrm{V}_{\text {OUT }}\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


Differential Gain \& Phase AC Coupled $\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


3rd Harmonic Distortion vs. $R_{L}\left(V_{S}=5 \mathrm{~V}\right)$


3rd Harmonic Distortion vs. $\mathrm{V}_{\text {OUT }}\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


Differential Gain \& Phase DC Coupled ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )


## Typical Performance Characteristics - Continued

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

Small Signal Pulse Response


Small Signal Pulse Response ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )


## Crosstalk vs. Frequency



Large Signal Pulse Response


Large Signal Pulse Response ( $\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ )


Crosstalk vs. Frequency $\left(\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$


Typical Performance Characteristics - Continued
$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{f}}=510 \Omega, \mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}_{\mathrm{S}} / 2, \mathrm{G}=2$; unless otherwise noted.

Closed Loop Output Impedance vs. Frequency


## PSRR vs. Frequency



CMRR vs. Frequency


Input Voltage vs. Output Current


## Application Information

## Basic Operation

Figures 1 and 2 illustrate typical circuit configurations for non-inverting, inverting, and unity gain topologies for dual supply applications. They show the recommended bypass capacitor values and overall closed loop gain equations.


Figure 1. Typical Non-Inverting Gain Circuit


Figure 2. Typical Inverting Gain Circuit

## Power Supply and Decoupling

The CLC2000 and CLC4000 can be powered with a low noise supply anywhere in the range from +5 V to +13 V . Ensure adequate metal connections to power pins in the PC board layout with careful attention paid to decoupling the power supply.

High quality capacitors with low equivalent series resistance (ESR) such as multilayer ceramic capacitors (MLCC) should be used to minimize supply voltage ripple and power dissipation.

Two decoupling capacitors should be placed on each power pin with connection to a local PC board ground plane. A large, usually tantalum, $10 \mu \mathrm{~F}$ to $47 \mu \mathrm{~F}$ capacitor is required to provide good decoupling for lower frequency signals and to provide current for fast, large signal changes at the CLC2000/CLC4000 outputs. It should be within 0.25 " of the pin. A secondary smaller $0.1 \mu \mathrm{~F}$ MLCC capacitor should located within $0.125^{\prime \prime}$ to reject higher frequency noise on the power line.

## Power Dissipation

Power dissipation is an important consideration in applications with low impedance DC, coupled loads. Guidelines listed below can be used to verify that the particular application will not cause the device to operate beyond its intended operating range. Calculations below relate to a single amplifier. For the CLC2000/CLC4000, all amplifiers power contribution needs to be added for the total power dissipation.

Maximum power levels are set by the absolute maximum junction rating of $150^{\circ} \mathrm{C}$. To calculate the junction temperature, the package thermal resistance value Theta $_{\text {JA }}$ $\left(\Theta_{\mathrm{JA}}\right)$ is used along with the total die power dissipation.
$\mathrm{T}_{\text {Junction }}=\mathrm{T}_{\text {Ambient }}+\left(\Theta_{\mathrm{JA}} \times \mathrm{P}_{\mathrm{D}}\right)$
Where $\mathrm{T}_{\text {Ambient }}$ is the temperature of the working environment.

In order to determine $\mathrm{P}_{\mathrm{D}}$, the power dissipated in the load needs to be subtracted from the total power delivered by the supplies.

$$
P_{D}=P_{\text {supply }}-P_{\text {load }}
$$

Supply power is calculated by the standard power equation.
$P_{\text {supply }}=V_{\text {supply }} \times I_{\text {(RMS supply) }}$
$\mathrm{V}_{\text {supply }}=\mathrm{V}_{\left(\mathrm{S}_{+}\right)}-\mathrm{V}_{(\mathrm{S}-)}$
Power delivered to a purely resistive load is:
$P_{\text {load }}=\left(\left(V_{\text {LOAD }}\right)_{\text {RMS }}{ }^{2}\right) /$ Rload $_{\text {eff }}$
The effective load resistor will need to include the effect of the feedback network. For instance,

Rload $_{\text {eff }}$ in figure 1 would be calculated as:
$R_{L} \|\left(R_{f}+R_{g}\right)$

These measurements are basic and are relatively easy to perform with standard lab equipment. For design purposes however, prior knowledge of actual signal levels and load impedance is needed to determine the dissipated power. Here, $P_{D}$ can be found from
$P_{D}=P_{\text {Quiescent }}+P_{\text {Dynamic }}-P_{\text {Load }}$
Quiescent power can be derived from the specified IS values along with known supply voltage, $\mathrm{V}_{\text {Supply. }}$. Load power can be calculated as above with the desired signal amplitudes using:
$\left(\mathrm{V}_{\text {LOAD }}\right)_{\text {RMS }}=\mathrm{V}_{\text {PEAK }} / \sqrt{ } 2$
$\left(\mathrm{I}_{\text {LOAD }}\right)_{\text {RMS }}=\left(\mathrm{V}_{\text {LOAD }}\right)_{\text {RMS }} /$ Rload $_{\text {eff }}$
The dynamic power is focused primarily within the output stage driving the load. This value can be calculated as:
$P_{\text {DYNAMIC }}=\left(\mathrm{V}_{\text {S+ }}-\mathrm{V}_{\text {LOAD }}\right)_{\text {RMS }} \times\left(\mathrm{I}_{\text {LOAD }}\right)_{\text {RMS }}$
Assuming the load is referenced in the middle of the power rails or $\mathrm{V}_{\text {supply }} / 2$.
Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 8 Lead SOIC packages.


Figure 3. Maximum Power Derating

Better thermal ratings can be achieved by maximizing PC board metallization at the package pins. However, be careful of stray capacitance on the input pins.

In addition, increased airflow across the package can also help to reduce the effective $\Theta_{\mathrm{JA}}$ of the package.

In the event of a short circuit condition, the CLC2000/ CLC4000 has circuitry to limit output drive capability to $\pm 1000 \mathrm{~mA}$. This will only protect against a momentary event. Extended duration under these conditions will cause junction temperatures to exceed $150^{\circ} \mathrm{C}$. Due to internal metallization constraints, continuous output current should be limited to $\pm 100 \mathrm{~mA}$.

## Driving Capacitive Loads

Increased phase delay at the output due to capacitive loading can cause ringing, peaking in the frequency response, and possible unstable behavior. Use a series resistance, $R_{S}$, between the amplifier and the load to help improve stability and settling performance. Refer to Figure 4.


Figure 4. Addition of $R_{S}$ for Driving Capacitive Loads

Table 1 provides the recommended $\mathrm{R}_{\mathrm{S}}$ for various capacitive loads. The recommended $\mathrm{R}_{\mathrm{S}}$ values result in $<=1 \mathrm{~dB}$ peaking in the frequency response. The Frequency Response vs. $C_{L}$ plots, on page 7, illustrates the response of the CLC2000.

| $\mathrm{C}_{\mathrm{L}}(\mathrm{pF})$ | $\mathrm{R}_{\mathrm{S}}(\Omega)$ | -3dB BW (MHz) |
| :---: | :---: | :---: |
| 10 | 40 | 275 |
| 20 | 24.5 | 250 |
| 50 | 20 | 175 |
| 100 | 13.5 | 135 |
| 500 | 6 | 75 |
| 1000 | 5 | 45 |

Table 1: Recommended RS vs. $C_{L}$
For a given load capacitance, adjust RS to optimize the tradeoff between settling time and bandwidth. In general, reducing $R_{S}$ will increase bandwidth at the expense of additional overshoot and ringing.

## Overdrive Recovery

An overdrive condition is defined as the point when either one of the inputs or the output exceed their specified voltage range. Overdrive recovery is the time needed for the amplifier to return to its normal or linear operating point. The recovery time varies, based on whether the input or output is overdriven and by how much the range is exceeded. The CLC2000/CLC4000 will typically recover in less than 40 ns from an overdrive condition. Figure 5 shows the CLC2000 in an overdriven condition.


Figure 5. Overdrive Recovery

Using the CLC2000/CLC4000 as a Differential Line Driver
The combination of good large signal bandwidth and high output drive capability makes the CLC2000/CLC4000 well suited for low impedance line driver applications, such as the upstream data path for a ADSL CPE modem. The dual channel configuration of the CLC2000 provides better channel matching than a typical single channel device, resulting in better overall performance in differential applications. When configured as a differential amplifier as in figure 6 , it can easily deliver the 13 dBm to a standard $100 \Omega$ twisted-pair CAT3 or CAT5 cable telephone network, as required in a ADSL CPE application.

Differential circuits have several advantages over singleended configurations. These include better rejection of common mode signals and improvement of power-supply rejection. The use of differential signaling also improves overall dynamic performance. Total harmonic distortion (THD) is reduced by the suppression of even signal harmonics and the larger signal swings allow for an improved signal to noise ratio (SNR).


Figure 6: Typical Differential Transmission Line Driver

For any transmission requirement, the fundamental design parameters needed are the effective impedance of the transmission line, the power required at the load, and knowledge concerning the content of the transmitted signal. The basic design of such a circuit is briefly outlined below, using the ADSL parameters as a guideline.

Data transmission techniques, such as ADSL, utilize amplitude modulation techniques which are sensitive to output clipping. A signal's PEAK to RMS ratio, or Crest Factor (CF), can be used to determine the adequate peak signal levels to insure fidelity for a given signal.
For an ADSL system, the signal consists of 256 independent frequencies with varying amplitudes. This results in a noise-like signal with a crest factor of about 5.3. If the driver does not have enough swing to handle the signal peaks, clipping will occur and amplitude modulated information can be corrupted, causing degradation in the signals Bit Error Rate.

To determine the required swing, first use the specified load impedance to convert the RMS power to an RMS voltage. Then, multiply the RMS voltage by the crest factor to get the peak values. For example 13dBm, as referenced to 1 mW , is $\sim 20 \mathrm{~mW}$. 20 mW into the $100 \Omega$ CAT5 impedance yields a RMS voltage of 1.413 VRMS. Using the ADSL crest factor of 5.3 yields $\sim \pm 7.5 \mathrm{~V}$ peak signals.

Line coupling through a 1:2 transformer is used to realize these levels. Standard back termination is used to match the characteristic $100 \Omega$ impedance of the CAT5 cable. For proper power transfer, this requires an effective 1:4 impedance match of $25 \Omega$ at the inputs of the transformer. To account for the voltage drop of the impedance matching resistors, the signal levels at the output of the amplifier need to be doubled. Thus each amplifier will swing $\pm 3.75 \mathrm{~V}$ about a centered common mode output voltage.

In general, the CLC2000/CLC4000 can be used in any application where an economical and local hardwired connection is needed. For example, routing analog or digital video information for a in-cabin entertainment system. Networking of a local surveillance system also could be considered.

## Layout Considerations

General layout and supply bypassing play major roles in high frequency performance. Exar has evaluation boards to use as a guide for high frequency layout and as aid in device testing and characterization. Follow the steps below as a basis for high frequency layout:

- Include $6.8 \mu \mathrm{~F}$ and $0.1 \mu \mathrm{~F}$ ceramic capacitors for power supply decoupling
- Place the $6.8 \mu \mathrm{~F}$ capacitor within 0.75 inches of the power pin
- Place the $0.1 \mu \mathrm{~F}$ capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- Minimize all trace lengths to reduce series inductances

Refer to the evaluation board layouts below for more information.

## Evaluation Board Information

The following evaluation board is available to aid in the testing and layout of this device:

| Evaluation Board | Products |
| :--- | :--- |
| CEB006 | CLC2000 |
| CEB018 | CLC4000 |

## Evalutaion Board Schematics

Evaluation board schematics and layouts are shown in Figures 7-9. These evaluation boards are built for dual- supply operation. Follow these steps to use the board in a single-supply application:

1. Short -Vs to ground.
2. Use C 3 and C 4 , if the $-V_{\mathrm{S}}$ pin of the amplifier is not directly connected to the ground plane.


Figure 7. CEB006 Schematic


Figure 8. CEB006 Top View


Figure 9. CEB006 Bottom View


BOARD MOUNTING HOLES



Figure 12. CEB018 Bottom View

Figure 10. CEB018 Schematic

## Mechanical Dimensions

## SOIC-8 Package



| SOIC-8 |  |  |
| :---: | :---: | :---: |
| SYMBOL | MIN | MAX |
| A1 | 0.10 | 0.25 |
| B | 0.36 | 0.48 |
| C | 0.19 | 0.25 |
| D | 4.80 | 4.98 |
| E | 3.81 | 3.99 |
| e | 1.27 BSC |  |
| H | 5.80 | 6.20 |
| h | 0.25 | 0.5 |
| L | 0.41 | 1.27 |
| A | 1.37 | 1.73 |
| $\theta_{1}$ | $0^{\circ}$ | $88^{\circ}$ |
| X | 0.55 ref |  |
| $\theta_{2}$ | $7^{\circ}$ BSC |  |

## NOTE:



1. All dimensions are in millimeters.
2. Lead coplanarity should be 0 to $0.1 \mathrm{~mm}\left(0.004^{\prime \prime}\right)$ max.
3. Package surface finishing: VDI $24 \sim 27$
4. All dimension excluding mold flashes.
5. The lead width, $B$ to be determined at 0.1905 mm from the lead tip.

## SOIC-14 Package

For Further Assistance:

## Exar Corporation Headquarters and Sales Offices

| 48720 Kato Road | Tel.: +1 (510) 668-7000 |
| :--- | :--- |
| Fremont, CA 94538-USA | Fax: +1 (510) 668-7001 |
|  | www.exar.com |

## NOTICE

Fax: +1 (510) 668-7001 www.exar.com

## NOTE:

1. All dimensions are in millimeters.
2. Lead coplanarity should be 0 to $0.1 \mathrm{~mm}\left(0.004^{\prime \prime}\right) \mathrm{mas}$
3. Package surface finishing: VDI $24 \sim 27$
4. All dimension excluding mold flashes.
5. The lead width, B to be determined at 0.1905 mm from the lead tip.

| SOIC-14 |  |  |
| :---: | :---: | :---: |
| SYMBOL | MIN | MAX |
| A1 | 0.10 | 0.25 |
| B | 0.36 | 0.48 |
| C | 0.19 | 0.25 |
| D | 8.56 | 8.74 |
| E | 3.84 | 3.99 |
| e | 1.27 BSC |  |
| H | 5.80 | 6.20 |
| h | 0.25 | 0.5 |
| L | 0.41 | 1.27 |
| A | 1.37 | 1.73 |
| $\theta_{1}$ | $0^{\circ}$ | $8^{\circ}$ |
| X | 0.51 ref |  |
| $\theta_{2}$ | $7^{\circ}$ BSC |  |



EXAR Corporation reserves the right to make changes to the products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no responsibility for the use of any
 purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.



Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Video Amplifiers category:
Click to view products by MaxLinear manufacturer:

Other Similar products are found below :
LT1193CN8 LT6552IDD\#PBF ADA4856-3YCPZ-R7 LT1253CN8\#PBF ADA4859-3ACPZ-R7 AD829SQ/883B AD8001ANZ AD8001AR AD8001ARTZ-REEL7 AD8002ARMZ AD8072ARMZ AD8072JNZ AD810ANZ AD8123ACPZ AD8123ACPZ-R7 AD812ANZ AD813ANZ AD8141ACPZ-R2 AD818ANZ AD828ANZ AD829JNZ AD829SQ AD8134ACPZ-R2 AD8134ACPZ-REEL7 ADA43101ARHZ ADA4310-1ARHZ-R7 ADA4433-1BCPZ-R2 ADA4433-1BCPZ-R7 ADA4433-1WBCPZ-R7 ADA4853-2YCPZ-R2 ADA48533YRUZ ADA4859-3ACPZ-R2 ADA4310-1ACPZ-R2 AD8073JRZ AD8023ARZ AD813ARZ-14 AD8013ARZ-14 AD813ARZ-14-REEL7 AD8145YCPZ-R7 AD8143ACPZ-REEL7 AD8372ACPZ-R7 ADA4853-2YCPZ-RL7 AD8002ARZ-R7 AD8072JRZ AD8001ARZ AD8002ARZ AD818ARZ-REEL7 AD829ARZ AD828ARZ AD8011ARZ

